

SPECIFICATION

DEVICE NAME : Power MOSFET

TYPE NAME : 2SK2850-01

SPEC. NO. : - - - - -

Electrónica S.A. de C.V.

Fuji Electric Co.,Ltd.

This Specification is subject to change without notice.

	DATE	NAME	APPROVED		Fuji Electric Co.,Ltd.
DRAWN					
CHECKED					

DWG. NO.		1/2

1.Scope This specifies Fuji Power MOSFET 2SK2850-01

2.Construction N-Channel enhancement mode power MOSFET

3.Applications for Switching

4.Outview TO-3P Outview See to 5/12 page

5.Absolute Maximum Ratings at Tc=25°C (unless otherwise specified)

Description	Symbol	Characteristics	Unit	Remarks
Drain-Source Voltage	V_{DS}	900	V	
Continuous Drain Current	I_D	± 6	A	
Pulsed Drain Current	I_{DP}	± 24	A	
Gate-Source Voltage	V_{GS}	± 30	V	
Maximum Avalanche Energy	E_{AV}	277	mJ	*1
Maximum Power Dissipation	P_D	125	W	
Operating and Storage	T_{ch}	150	°C	
Temperature range	T_{stg}	-55 to +150	°C	

*1 L=14.1mH, Vcc=90V

6.Electrical Characteristics at Tc=25°C (unless otherwise specified)

Static Ratings

Description	Symbol	Conditions	min.	typ.	max.	Unit
Drain-Source Breakdown Voltage	BV_{DSS}	$I_D=1mA$ $V_{GS}=0V$	900			V
Gate Threshold Voltage	$V_{GS(th)}$	$I_D=1mA$ $V_{DS}=V_{GS}$	2.5	3.0	3.5	V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=900V$ $V_{GS}=0V$		10	500	μA
		$T_{ch}=125^\circ C$		0.2	1.0	mA
Gate-Source Leakage Current	I_{GSS}	$V_{GS}=\pm 30V$ $V_{DS}=0V$		10	100	nA
Drain-Source On-State Resistance	$R_{DS(on)}$	$I_D=3A$ $V_{GS}=10V$		1.87	2.5	Ω

Dynamic Ratings

Description	Symbol	Conditions	min.	typ.	max.	Unit
Forward Transconductance	g_{fs}	$I_D=3A$ $V_{DS}=25V$	2.0	4.0		S
Input Capacitance	C_{iss}	$V_{DS}=25V$ $V_{GS}=0V$ $f=1MHz$		950	1450	pF
Output Capacitance	C_{oss}			140	210	
Reverse Transfer Capacitance	C_{rss}			80	120	
Turn-On Time	$t_d(on)$	$V_{cc}=600V$		20	30	ns
	t_r	$V_{GS}=10V$		50	80	
Turn-Off Time	$t_d(off)$	$I_D=6A$		110	170	
	t_f	$R_{GS}=10\Omega$		60	90	

Reverse Diode

Description	Symbol	Conditions	min.	typ.	max.	Unit
Avalanche Capability	I_{AV}	$L=100\mu H$ $T_{ch}=25^\circ C$ See Fig.1 and Fig.2	6			A
Diode Forward On-Voltage	V_{SD}	$I_F=2 \times I_{DR}$ $V_{GS}=0V$ $T_{ch}=25^\circ C$		1.0	1.5	V
Reverse Recovery Time	t_{rr}	$I_F=I_{DR}$		900		ns
Reverse Recovery Charge	Q_{rr}	$-di/dt=100A/\mu s$ $T_{ch}=25^\circ C$		10		μC

7. Thermal Resistance

Description	Symbol	min.	typ.	max.	Unit
Channel to Case	$R_{th(ch-c)}$			1.00	$^\circ C/W$
Channel to Ambient	$R_{th(ch-a)}$			35.0	$^\circ C/W$

Fig.1 Test Circuit

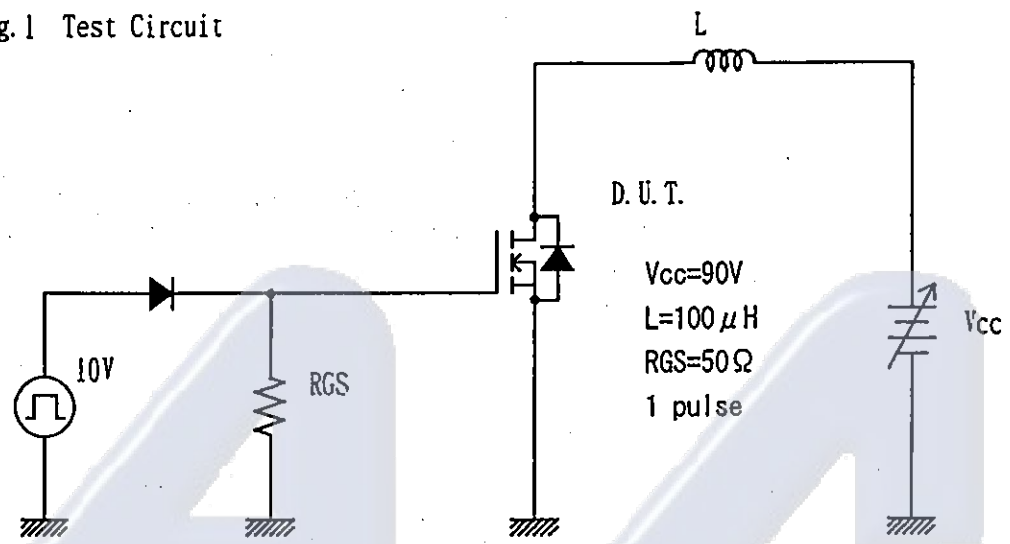
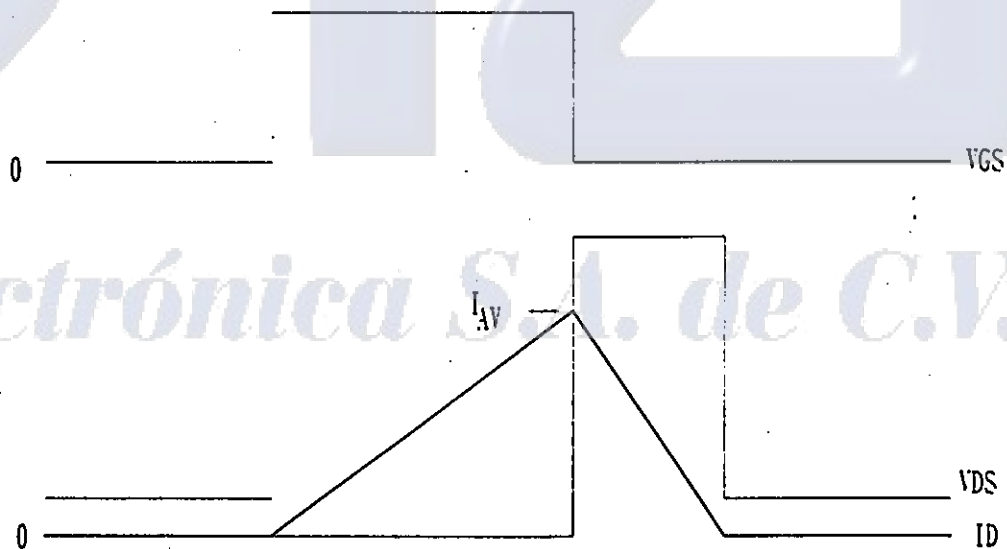
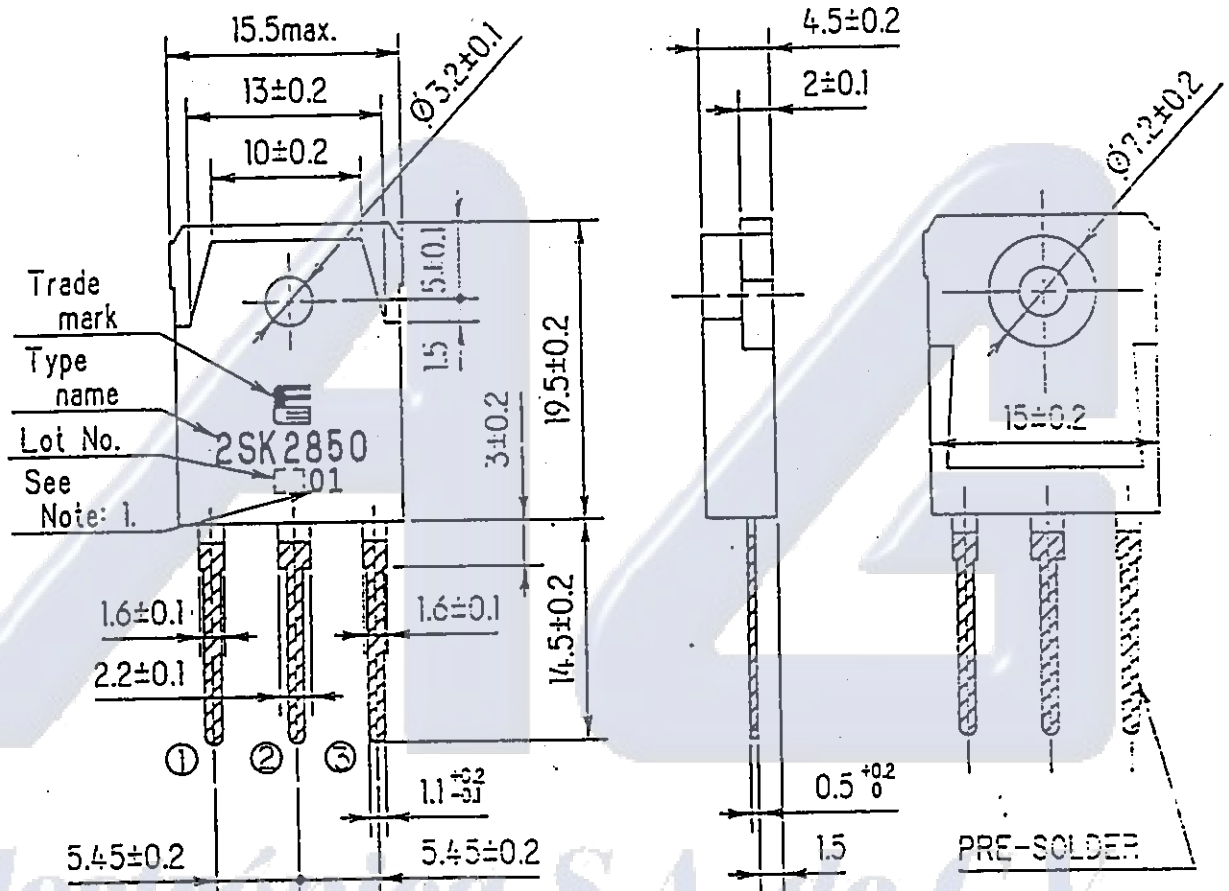
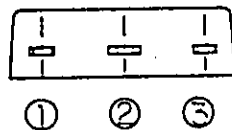


Fig.2 Operating waveforms



FUJI POWER MOS FETTYPE : 2SK2850-01

DIMENSIONS ARE IN MILLIMETERS.

CONNECTION

- ① GATE
- ② DRAIN
- ③ SOURCE

Note: 1. Guaranteed mark of
avalanche ruggedness.

JEDEC : TO-247
EIAJ : SC-65

Fuji Electric Co., Ltd.

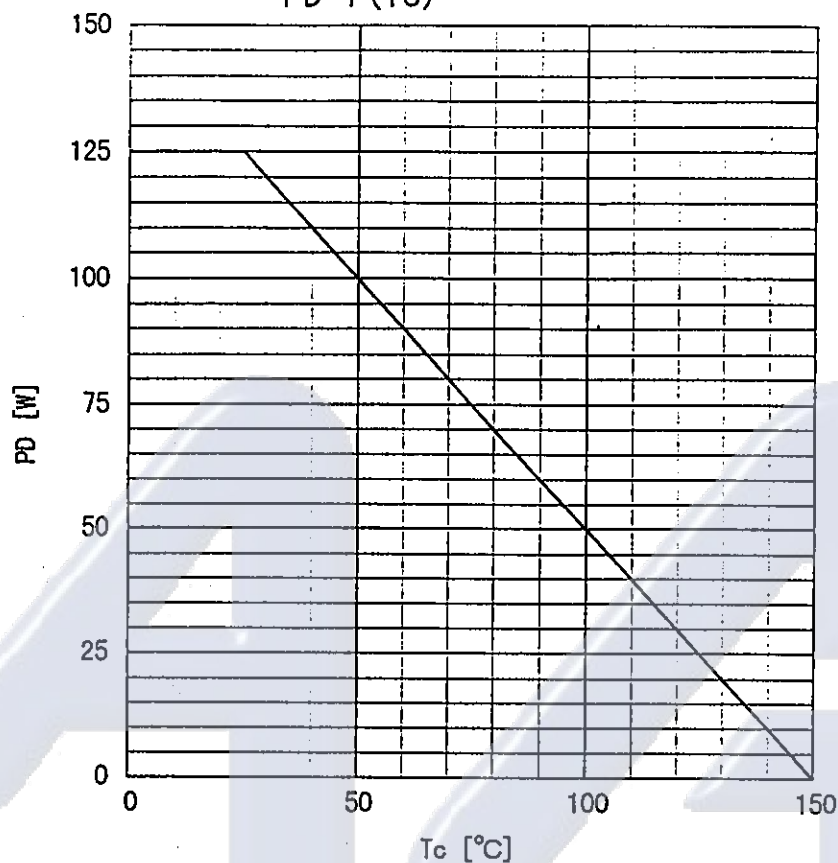
DWG. NO.

5/12

This material and the information herein is the property of Fuji Electric Co., Ltd. They shall be neither reproduced, copied, lent, or disclosed in any way whatsoever for the use of any third party nor used for the manufacturing purposes without the express written consent of Fuji Electric Co., Ltd.

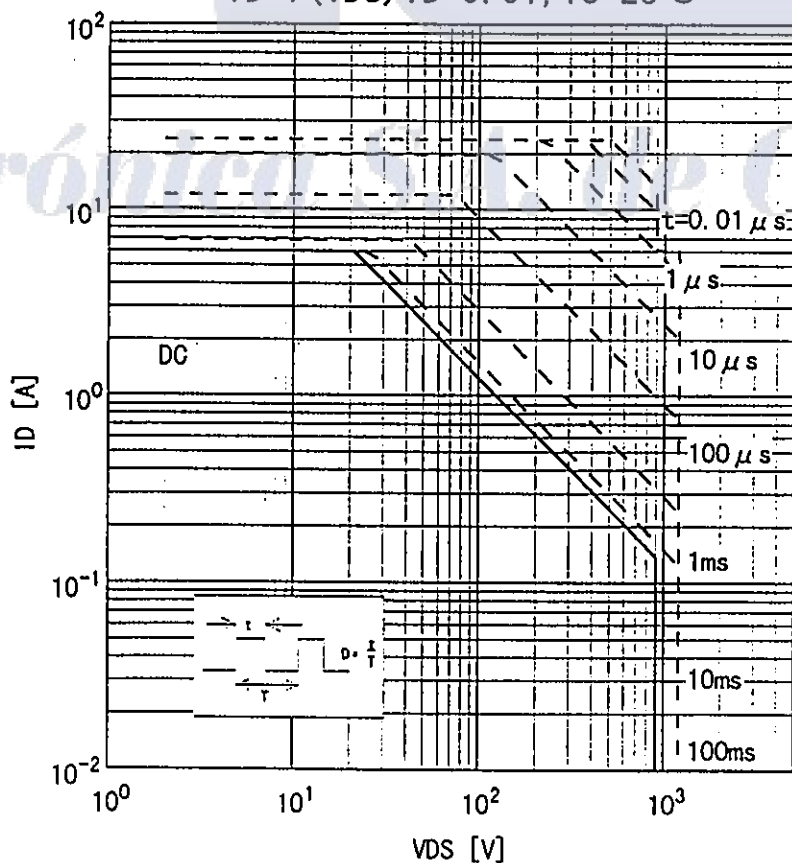
Power Dissipation

$$PD=f(T_c)$$

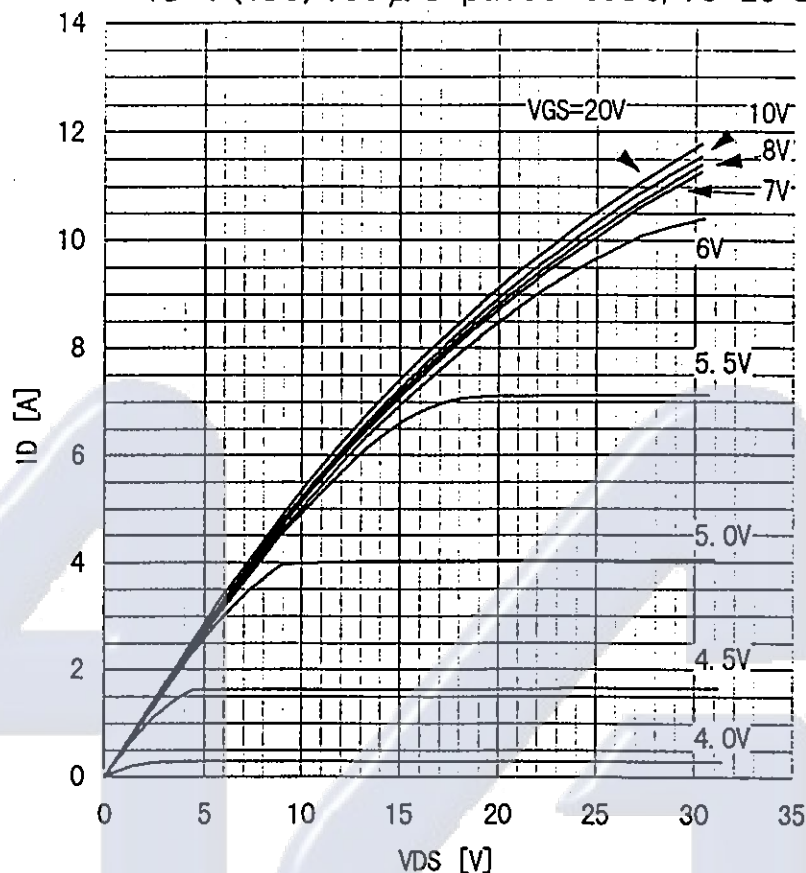


Safe operating area

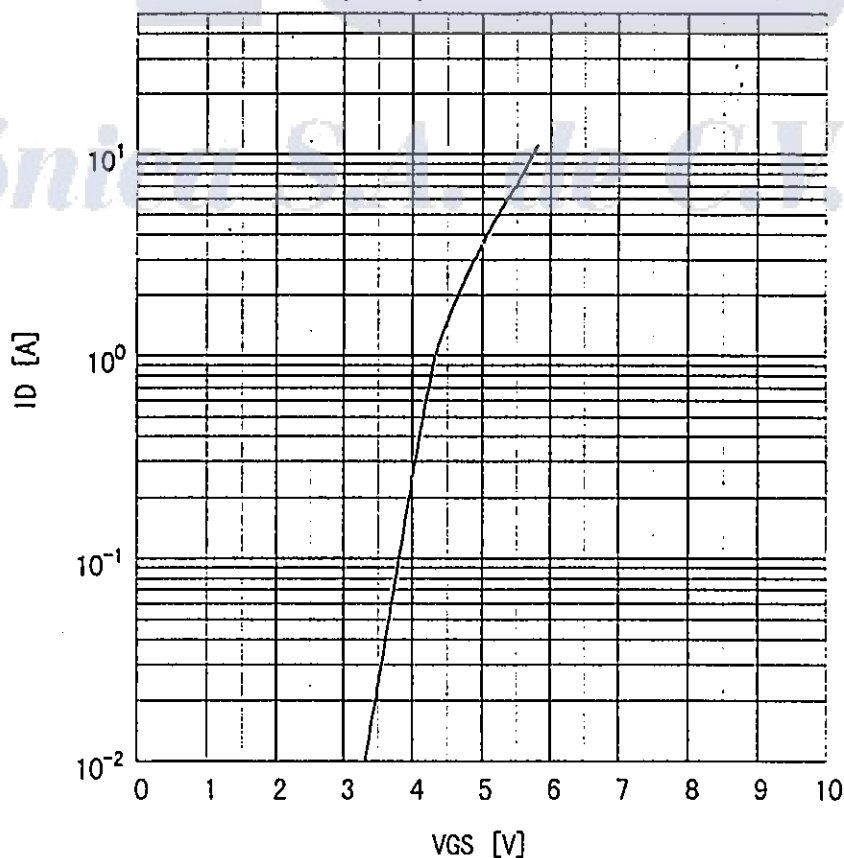
$$ID=f(V_{DS}):D=0.01, T_c=25^{\circ}C$$



Typical output characteristics

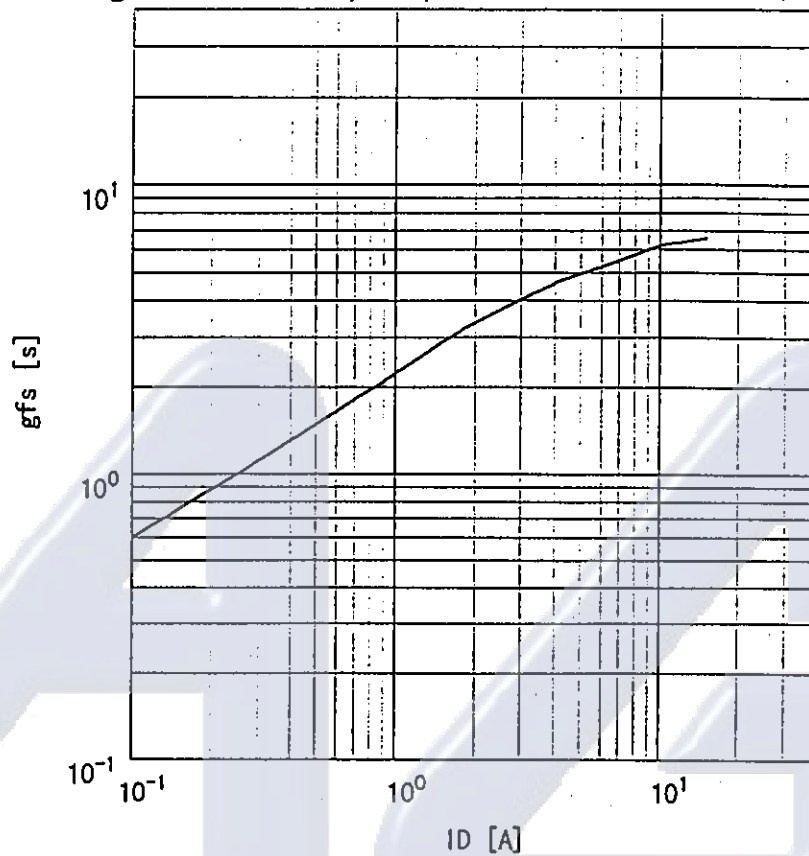
 $I_D = f(V_{DS})$: 80 μ s pulse test, $T_C = 25^\circ\text{C}$ 

Typical transfer characteristic

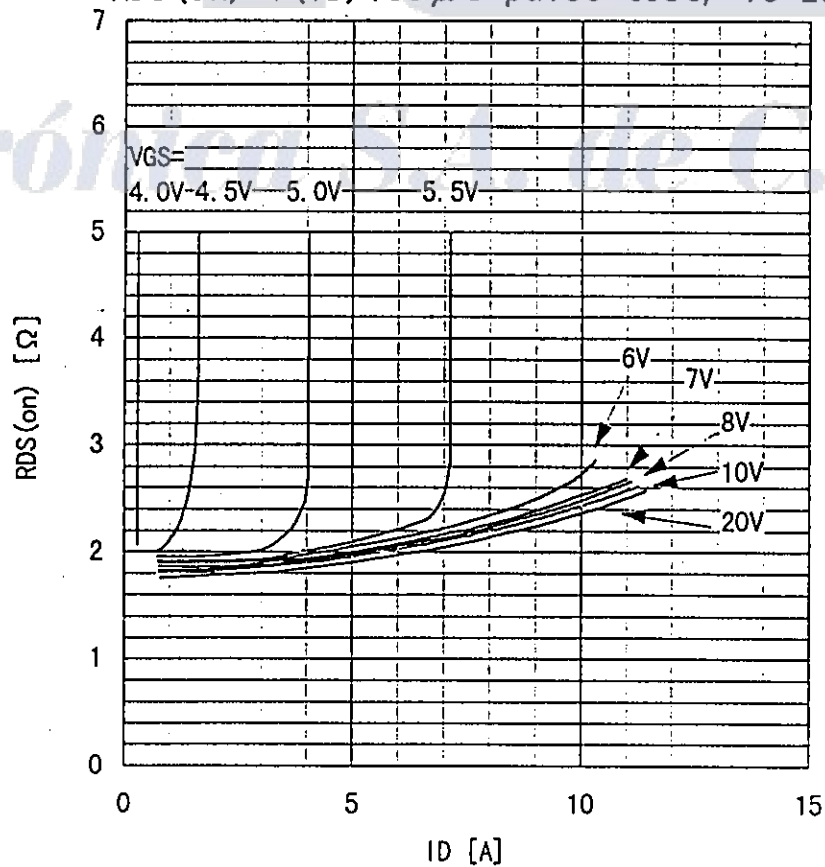
 $I_D = f(V_{GS})$: 80 μ s pulse test, $V_{DS} = 25\text{V}$, $T_{ch} = 25^\circ\text{C}$ 

This material and the information herein is the property of Fuji Electric Co., Ltd. They shall be neither reproduced, copied, lent, or disclosed in any way whatsoever for the use of any third party nor used for the manufacturing purposes without the express written consent of Fuji Electric Co., Ltd.

Typical forward transconductance
 $g_{fs}=f(I_D)$: 80 μ s pulse test, $V_{DS}=25V$, $T_{ch}=25^\circ C$



Typical drain-source on-state resistance
 $R_{DS(on)}=f(I_D)$: 80 μ s pulse test, $T_c=25^\circ C$

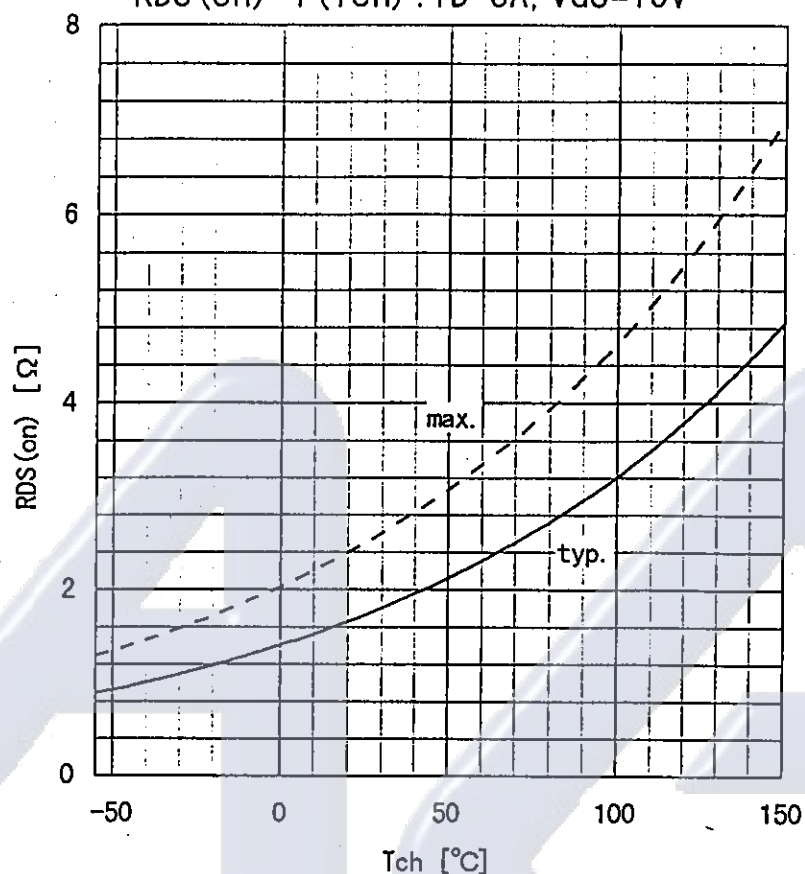


This material and the information herein is the property of Fuji Electric Co., Ltd. They shall be neither reproduced, copied, lent, or disclosed in any way whatsoever for the use of any third party nor used for the manufacturing purposes without the express written consent of Fuji Electric Co., Ltd.

This material and the information herein is the property of Fuji Electric Co., Ltd. They shall be neither reproduced, copied, lent, or disclosed in any way whatsoever for the use of any third party nor used for the manufacturing purposes without the express written consent of Fuji Electric Co., Ltd.

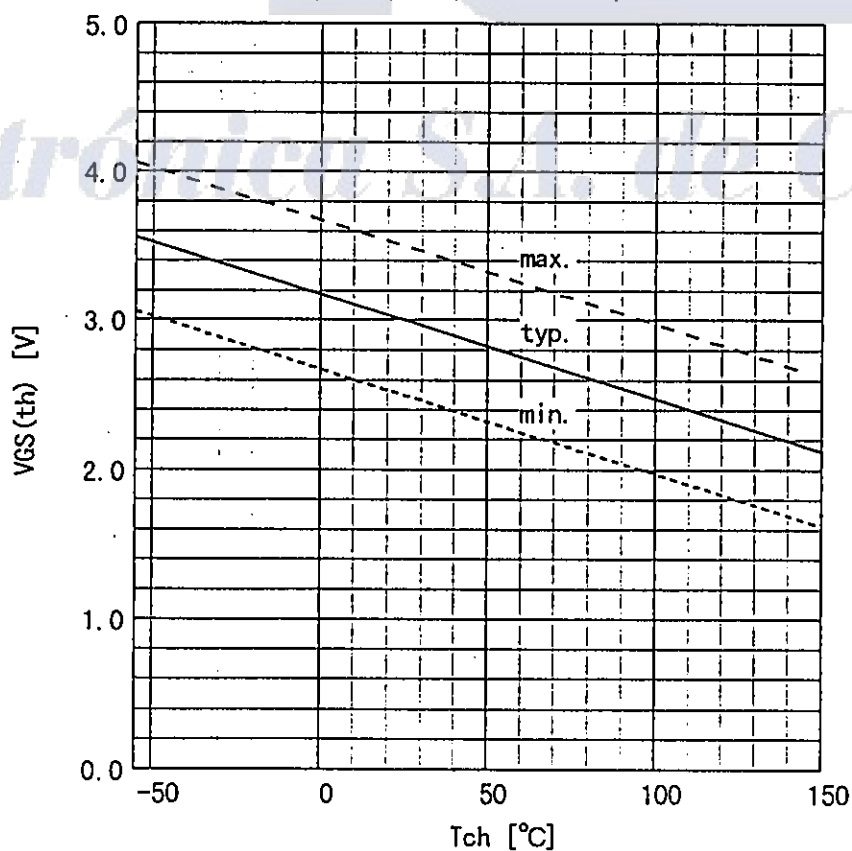
Drain-source on-state resistance

$$R_{DS(on)} = f(T_{ch}) : I_D = 3A, V_{GS} = 10V$$



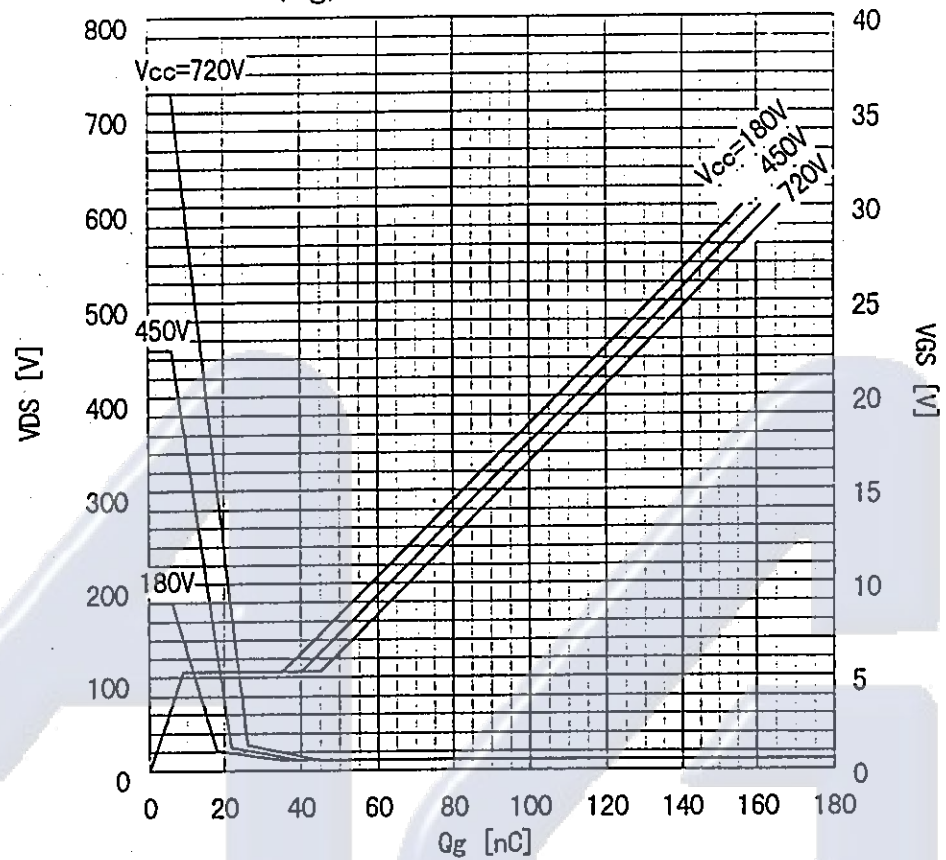
Gate threshold voltage

$$V_{GS(th)} = f(T_{ch}) : I_D = 1mA, V_{DS} = V_{GS}$$

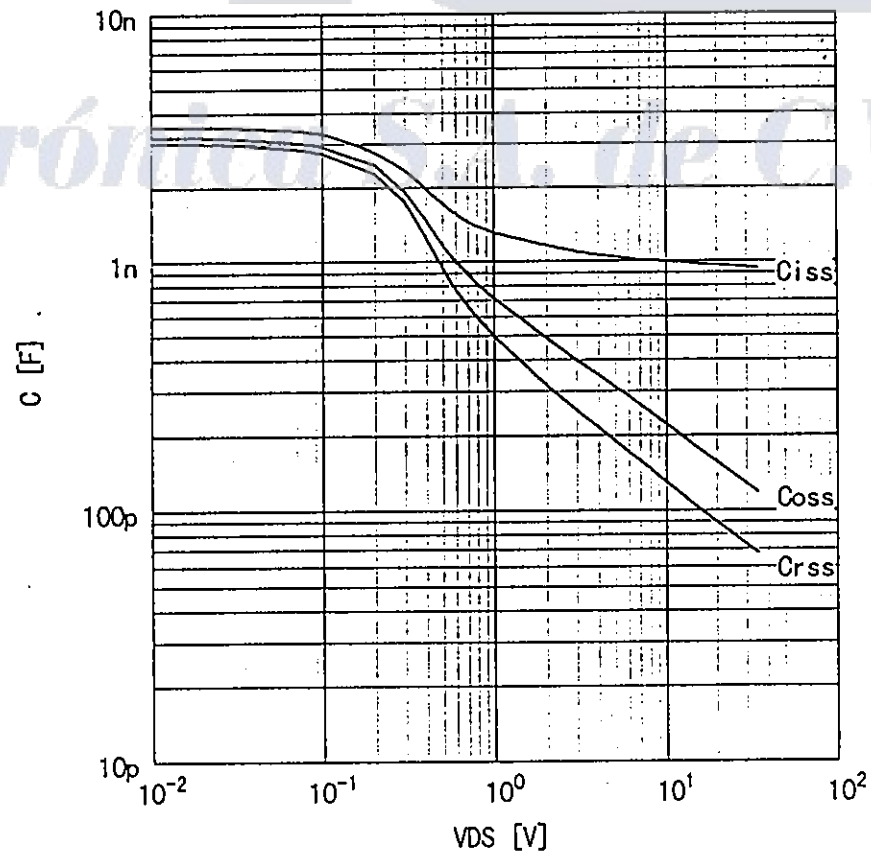


This material and the information herein is the property of Fuji Electric Co., Ltd. They shall be neither reproduced, copied, lent, or disclosed in any way whatsoever for the use of any third party nor used for the manufacturing purposes without the express written consent of Fuji Electric Co., Ltd.

Typical gate charge characteristic
 $V_{GS}=f(Q_g) : I_D=6A, T_c=25^\circ C$

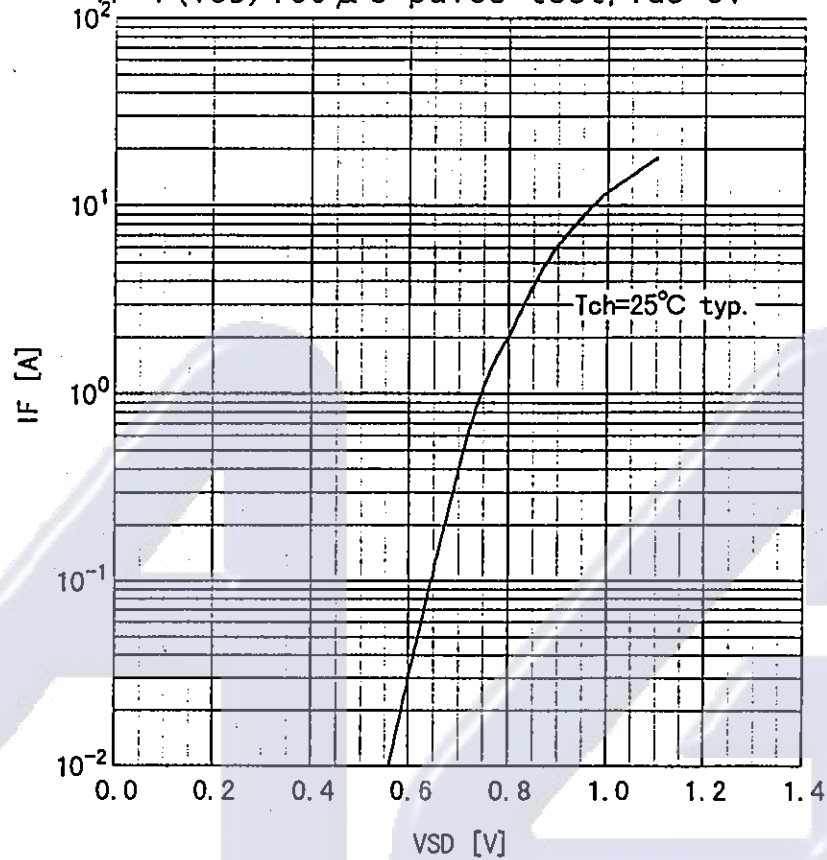


Typical capacitances
 $C=f(V_{DS}) : V_{GS}=0V, f=1MHz$



Forward characteristic of reverse of diode

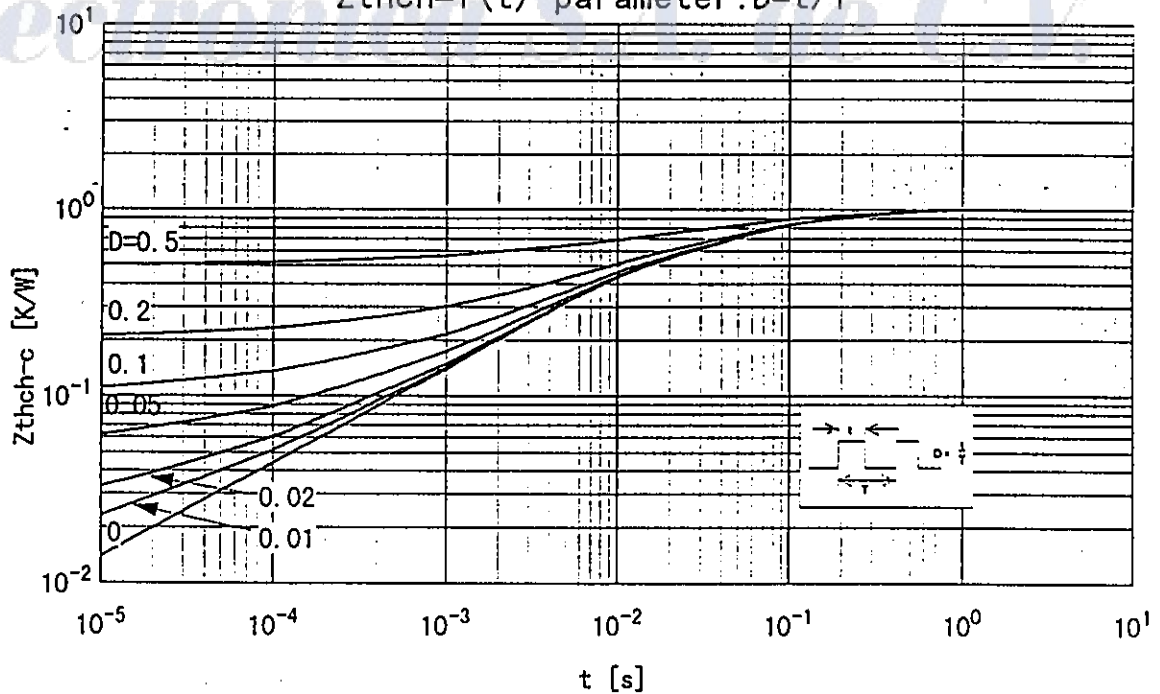
$I_F = f(V_{SD}) : 80 \mu s$ pulses test, $V_{GS} = 0V$



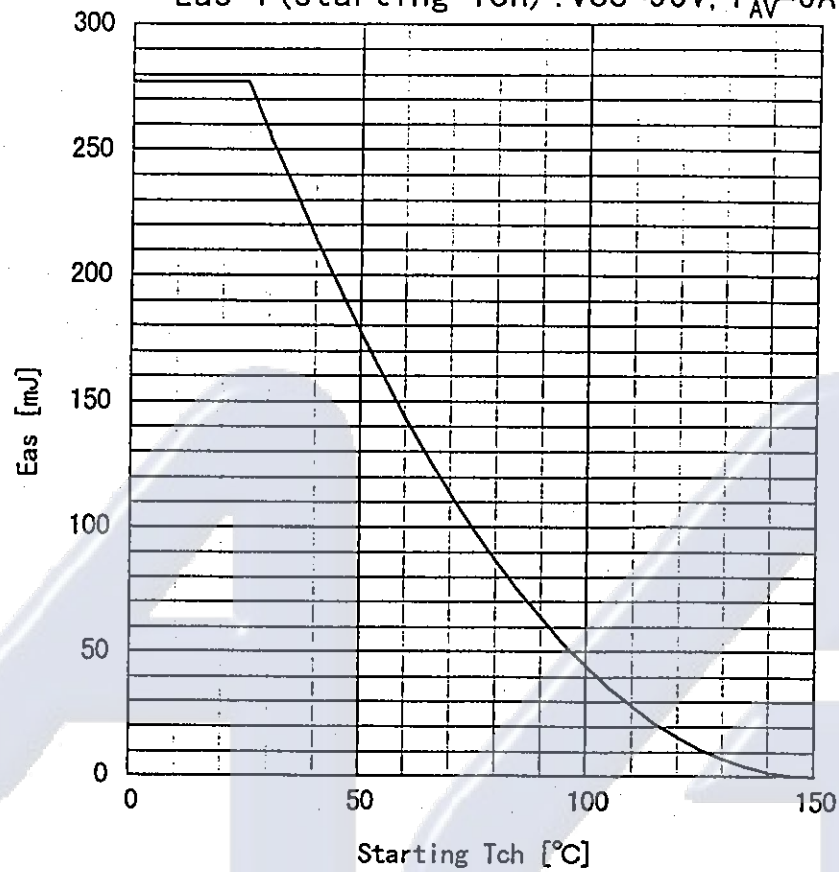
This material and the information herein is the property of Fuji Electric Co., Ltd. They shall be neither reproduced, copied, lent, or disclosed in any way whatsoever for the use of any third party nor used for the manufacturing purposes without the express written consent of Fuji Electric Co., Ltd.

Transient thermal impedance

$Z_{thch} = f(t)$ parameter: $D = t/T$



Avalanche energy derating

 $E_{as}=f(\text{starting } T_{ch}) : V_{cc}=90V, I_{AV}=6A$ 

This material and the information herein is the property of Fuji Electric Co., Ltd. They shall be neither reproduced, copied, lent, or disclosed in any way whatsoever for the use of any third party nor used for the manufacturing purposes without the express written consent of Fuji Electric Co., Ltd.

Electrónica S.A. de C.V.